

**SPEC. NO.:** PS-52006-XXXXX-XXX

**REVISION:** A

**PRODUCT NAME:** 0.50mm PITCH BTB D/R CONN SMT S/T TYPE

**PRODUCT NO:** 52006,52007

<b>PREPARED:</b>   <b>DATE:</b> <b>2020/09/15</b>	<b>CHECKED:</b>   <b>DATE:</b> <b>2020/09/15</b>	<b>APPROVED:</b>   <b>DATE:</b> <b>2020/09/15</b>
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TITLE: **0.50 mm PITCH BTB D/R CONN SMT S/T TYPE**

RELEASE DATE: 2020/09/15

REVISION: A

ECN No: ECN-000342

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Aces P/N: **52006,52007 series**

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### 1 Revision History

Rev.	ECN #	Revision Description	Approved	Date
A	ECN-000342	NEW SPEC	Rong,Li Ping	2020/09/15

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## 2 SCOPE

This specification covers performance, tests and quality requirements for 0.50mm pitch BTB connector. ACES P/N: 52006,52007 Series.

## 3 APPLICABLE DOCUMENTS

**EIA-364**      **ELECTRONICS INDUSTRIES ASSOCIATION**

## 4 REQUIREMENTS

### 4.1 Design and Construction

- 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
- 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.

### 4.2 Materials and Finish

- 4.2.1 Contact: High performance copper alloy  
Finish: (a) Contact Area: Refer to the drawing  
(b) Under plate: Refer to the drawing
- 4.1.2 Housing: Thermoplastic High Temp., UL94V-0

### 4.3 Ratings

- 4.3.1 Working Voltage Less than 36 Volts AC(per pin)
- 4.3.2 Voltage: 60 Volts AC (per pin)
- 4.3.3 Current: 0.5 Amperes (per pin)
- 4.3.4 Operating Temperature : -40°C to +80°C

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## 5 Performance

### 5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard		
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.		
<b>ELECTRICAL</b>				
Item	Requirement	Standard		
Low Level Contact Resistance	60 m Ω Max.(Initial)per contact 60 m Ω Max.(Final)	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)		
Insulation Resistance	500 M Ω Min. (Initial) 100 M Ω Min. (Final)	Unmated connectors, apply 500 V DC between adjacent terminals.  (EIA-364-21)		
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max..	250 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)		
Temperature rise	30°C Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70,METHOD1,CONDITION1)		
<b>MECHANICAL</b>				
Item	Requirement	Standard		
Durability	30 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min. (EIA-364-09)		
Mating / Unmating Forces	Unit: Kg		Operation Speed : 25.4 ± 3 mm/minute. Measure the force required to mate/Unmate connector. (EIA-364-13)	
	Pins	Mating Force(Max) Initial    Final		Unmating Force(Min) Initial    Final
	60~80	8.0    7.0		0.7    0.5
	100~120	9.0    8.0		0.8    0.6

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Terminal / Housing Retention Force	0.2kgf MIN.	Apply axial pull out force at the speed rate of $25.4 \pm 3$ mm/minute. On the terminal assembled in the housing.
Vibration	1 $\mu$ s Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)
Shock (Mechanical)	1 $\mu$ s Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)

**ENVIRONMENTAL**

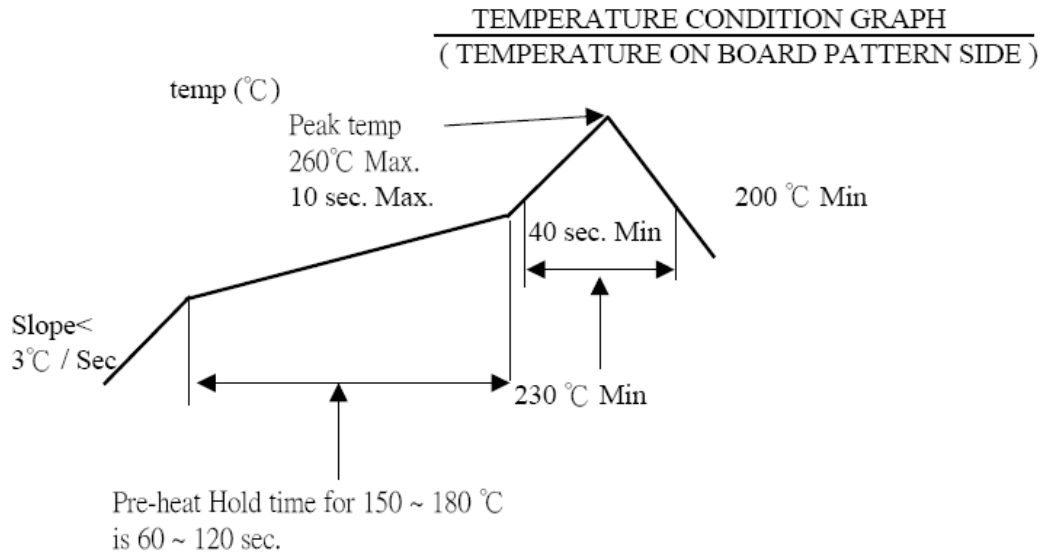
Item	Requirement	Standard
Resistance to Reflow Soldering Heat	See Product Qualification and Test Sequence Group 9 ( <b>Lead Free</b> )	Pre Heat : $150^{\circ}\text{C} \sim 180^{\circ}\text{C}$ , 60~120sec. Heat : $230^{\circ}\text{C}$ Min., 40sec Min. Peak Temp. : $260^{\circ}\text{C}$ Max, 10sec Max. Reflow number cycle: 2 times
Thermal Shock	See Product Qualification and Test Sequence Group 4	Mate module and subject to follow condition for 5 cycles. 1 cycles: $-40 +0/-3^{\circ}\text{C}$ , 30 minutes $+85 +3/-0^{\circ}\text{C}$ , 30 minutes (EIA-364-32, test condition A)
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector $40^{\circ}\text{C}$ , 75~80% RH, Reefer to Method II. (EIA-364-31, Test condition A)

Temperature life	See Product Qualification and Test Sequence Group 5	Subject mated connectors to temperature life at 85°C for 96 hours. Measure Signal. (EIA-364-17, Test condition A)
Salt Spray	See Product Qualification and Test Sequence Group 6	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C for 24 hours. (EIA-364-26, Test condition B)
Solder ability	Solder able area shall have minimum of 95% solder coverage.	And then into solder bath, Temperature at 260 ±5°C, for 4-5 sec. (EIA-364-52)

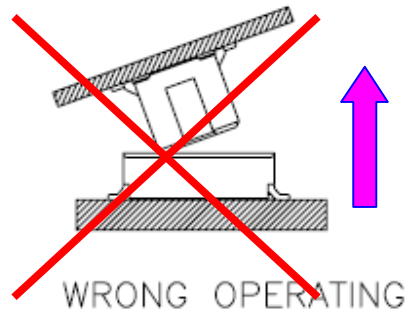
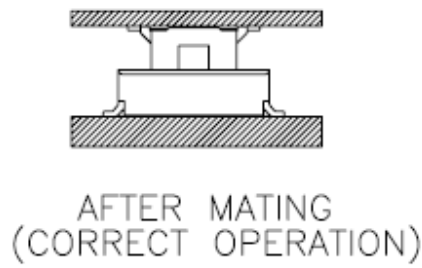
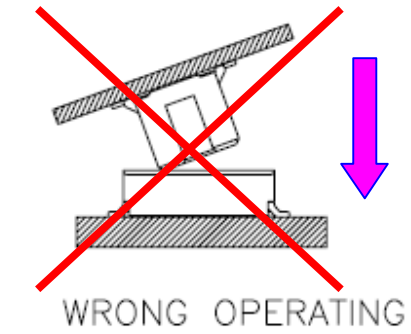
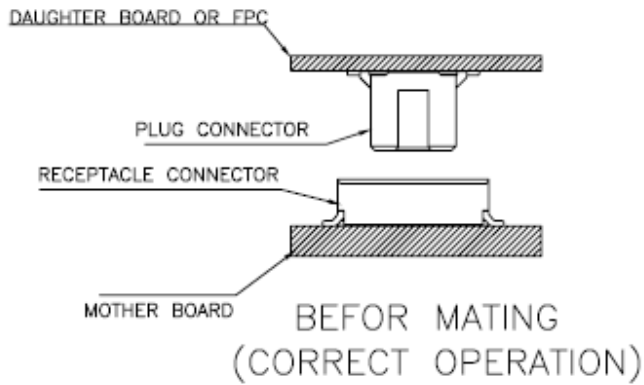
**Note.** Flowing Mixed Gas shall be conduct by customer request.

## 6 INFRARED REFLOW CONDITION

### 6.1. Lead-free Process



### 7 CONNECTOR USAGE





**8 PRODUCT QUALIFICATION AND TEST SEQUENCE**

Test or Examination	Test Group									
	1	2	3	4	5	6	7	8	9	
	Test Sequence									
Examination of Product				1、7	1、6	1、4			1	
Low Level Contact Resistance		1、5	1、4	2、10	2、9	2、5			3	
Insulation Resistance				3、9	3、8					
Dielectric Withstanding Voltage				4、8	4、7					
Mating / Unmating Forces		2、4								
Temperature rise	1									
Durability		3								
Vibration			2							
Shock (Mechanical)			3							
Thermal Shock				5						
Humidity				6						
Temperature life					5					
Salt Spray						3				
Solder ability							1			
Terminal / Housing Retention Force								1		
Resistance to Soldering Heat									2	
Sample Size	2	4	4	4	4	4	2	4	4	